UNITED STATES INTERNATIONAL TRADE COMMISSION

Washington, D.C.

In the Matter of

CERTAIN SEMICONDUCTOR LITHOGRAPHY SYSTEMS AND COMPONENTS THEREOF Inv. No. 337-TA-1137

ORDER NO. 4: PROCEDURAL SCHEDULE

(November 26, 2018)

Pursuant to Order No. 3 (Nov. 1, 2018), the parties submitted a proposed procedural schedule, which was adopted during a teleconference on November 16, 2018. The investigation shall proceed in accordance with the deadlines set forth below:

EVENT	DEADLINE
First Settlement Conference	January 31, 2019
Submission of first settlement conference joint report	February 7, 2019
Exchange Proposed Claim Constructions ²	February 15, 2019
File notice of prior art	February 22, 2019
File tentative list of witnesses a party will call to testify at the hearing	February 22, 2019
Initial Markman Briefs	March 1, 2019
Attendance at one-day mediation session ³	March 4, 2019
Submission of joint report on mediation	March 11, 2019
Rebuttal Markman Briefs	March 15, 2019
File identification of expert witnesses, including their expertise and curriculum vitae	March 22, 2019

¹ Complainant is hereby ORDERED to file a transcript of the teleconference into the record.

² The parties also proposed a deadline for exchanging proposed terms for construction, which is not included in this order. The parties may agree to such dates by stipulation.

³ The parties have indicated that a mediation is likely to take place earlier with respect to several proceedings involving the same parties.

EVENT	DEADLINE
Markman Hearing and Technology Tutorial	April 3, 2019
Fact discovery cutoff and completion	April 10, 2019
Exchange of initial expert reports (identify tests/surveys/data)	April 15, 2019
Exchange of rebuttal expert reports	May 8, 2019
Deadline for motions to compel discovery	May 15, 2019
Expert discovery cutoff and completion	May 22, 2019
Deadline for filing summary determination motions	May 30, 2019
Second settlement conference	May 30, 2019
Exchange of exhibit lists among the parties	June 4, 2019
Submission of second settlement conference joint report	June 6, 2019
Exchange proposed direct exhibits (including witness statements, demonstratives, and deposition designations, and adverse witness outlines), with physical exhibits available ⁴	June 7, 2019
Exchange proposed rebuttal exhibits (including witness statements, demonstratives, deposition counter/rebuttal designations, and adverse witness outlines), with rebuttal physical exhibits available	June 21, 2019
Deadline for motions in limine	June 27, 2019
File high priority objections statement	June 27, 2019
File pre-hearing statements and briefs	July 2, 2019
Submit proposed exhibits to Administrative Law Judge	July 10, 2019
File responses to motions in limine	July 11, 2019
File responses to high priority objections statement	July 11, 2019
Pre-hearing conference	July 29, 2019
Hearing	July 29 – August 2, 2019
File initial post-hearing briefs and final exhibit lists	August 15, 2019
File reply post-hearing briefs	August 23, 2019
Initial Determination due	October 24, 2019
Target date for completion of investigation	February 24, 2020

SO ORDERED.

Dee Lord

Administrative Law Judge

⁴ Requests for receipt of evidence without a sponsoring witness shall also be filed on this date.

PUBLIC CERTIFICATE OF SERVICE

I, Lisa R. Barton, hereby certify that the attached ORDER has been served upon the following parties as indicated, on November 26, 2018.

Lisa R. Barton, Secretary U.S. International Trade Commission 500 E Street, SW, Room 112 Washington, DC 20436

On Behalf of Complainants ASML Netherlands B. V., ASML US, L.P., ASML US, LLC:

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